

Carbon nanotubes at heart of new system to cool 'power electronics'

I-Micronews

The miniature, lightweight device uses tiny copper spheres and carbon nanotubes to passively wick a coolant toward hot electronics, said Suresh V. Garimella, the R. Eugene and Susie E. Goodson Distinguished Professor of Mechanical Engineering at Purdue University.

This wicking technology represents the heart of a new ultrathin "thermal ground plane," a flat, hollow plate containing water. Similar "heat pipes" have been in use for more than two decades and are found in laptop computers. However, they are limited to cooling about 50 watts per square centimeter, which is good enough for standard computer chips but not for "power electronics" in military weapons systems and hybrid and electric vehicles, Garimella said.

The research team from Purdue, Thermacore Inc. and Georgia Tech Research Institute is led by Raytheon Co., creating the compact cooling technology in work funded by the Defense Advanced Research Projects Agency, or DARPA.

The team is working to create heat pipes about one-fifth the thickness of commercial heat pipes and covering a larger area than the conventional devices, allowing them to provide far greater heat dissipation.

New findings indicate the wicking system that makes the technology possible absorbs more than 550 watts per square centimeter, or about 10 times the heat generated by conventional chips. This is more than enough cooling capacity for the power-electronics applications, Garimella said.

The findings are detailed in a research paper appearing online this month in the International Journal of Heat and Mass Transfer and will be published in the journal's September issue. The paper was written by mechanical engineering doctoral student Justin Weibel, Garimella and Mark North, an engineer with Thermacore, a producer of commercial heat pipes located in Lancaster, Pa.

"We know the wicking part of the system is working well, so we now need to make sure the rest of the system works," **North** said.

The new type of cooling system can be used to prevent overheating of devices called insulated gate bipolar transistors, high-power switching transistors used in hybrid and electric vehicles. The chips are required to drive electric motors, switching large amounts of power from the battery pack to electrical coils needed to accelerate a vehicle from zero to 60 mph in 10 seconds or less.

Potential military applications include advanced systems such as radar, lasers and

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electronics in aircraft and vehicles. The chips used in the automotive and military applications generate 300 watts per square centimeter or more.

Researchers are studying the cooling system using a novel test facility developed by Weibel that mimics conditions inside a real heat pipe.

"The wick needs to be a good transporter of liquid but also a very good conductor of heat," Weibel said. "So the research focuses largely on determining how the thickness of the wick and size of copper particles affect the conduction of heat."

Computational models for the project were created by Garimella in collaboration with Jayathi Y. Murthy, a Purdue professor of mechanical engineering, and doctoral student Ram Ranjan. The carbon nanotubes were produced and studied at the university's Birck Nanotechnology Center in work led by mechanical engineering professor Timothy Fisher.

"We have validated the models against experiments, and we are conducting further experiments to more fully explore the results of simulations," Garimella said.

Inside the cooling system, water circulates as it is heated, boils and turns into a vapor in a component called the evaporator. The water then turns back to a liquid in another part of the heat pipe called the condenser.

The wick eliminates the need for a pump because it draws away fluid from the condenser side and transports it to the evaporator side of the flat device, Garimella said.

Allowing a liquid to boil dramatically increases how much heat can be removed compared to simply heating a liquid to temperatures below its boiling point. Understanding precisely how fluid boils in tiny pores and channels is helping the engineers improve such cooling systems.

The wicking part of the heat pipe is created by sintering, or fusing together tiny copper spheres with heat. Liquid is drawn sponge-like through spaces, or pores, between the copper particles by a phenomenon called capillary wicking. The smaller the pores, the greater the drawing power of the material, Garimella said.

Such sintered materials are used in commercial heat pipes, but the researchers are improving them by creating smaller pores and also by adding the carbon nanotubes.

"For high drawing power, you need small pores," Garimella said. "The problem is that if you make the pores very fine and densely spaced, the liquid faces a lot of frictional resistance and doesn't want to flow. So the permeability of the wick is also important."

The researchers are creating smaller pores by "nanostructuring" the material with carbon nanotubes, which have a diameter of about 50 nanometers, or billionths of a meter. However, carbon nanotubes are naturally hydrophobic, hindering their wicking ability, so they were coated with copper using a device called an electron

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beam evaporator.

"We have made great progress in understanding and designing the wick structures for this application and measuring their performance," said **Garimella**. He said that once ongoing efforts at packaging the new wicks into heat pipe systems that serve as the thermal ground plane are complete, devices based on the research could be in commercial use within a few years.

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